

Low Dropout CMOS Voltage Regulators

LM1114

Features

- Maximum output current 250mA
- Highly accurate : output voltage \pm 2%
- Low power consumption : typ. 1 μ A
- Small input/output differential:
 0.45V typ at 160mA(2.5V, 3.0V, 3.3V, 3.6V)
 0.4V typ at 200mA(V_{out} =5V)
- Pb-free lead plating and halogen-free package

Applications

- Battery powered equipment
- Palmtops
- Portable cameras and video recorders
- Reference voltage sources

Product Description

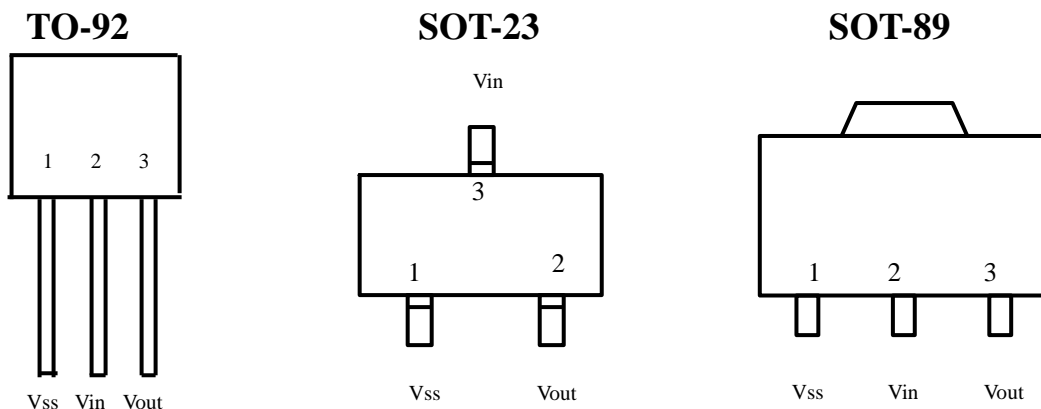
The LM1114 series is a group of positive voltage output, three-pin regulators, that provide a high current even when the input/output voltage differential is small. Low power consumption and high accuracy is achieved through CMOS and programmable fuse technologies.

The LM1114 consists of a high-precision voltage reference, an error correction circuit, and a current limited output driver. Transient response to load variations is improved in comparison to the existing ones.

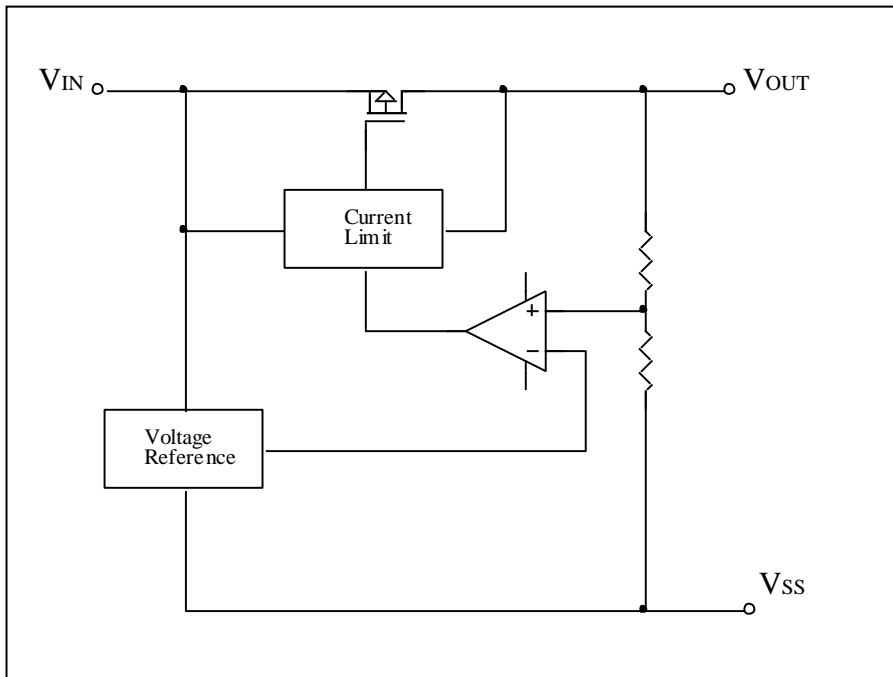
Absolute Maximum Ratings

Parameter	Symbol	Ratings	Units
Input Voltage	V_{in}	12	V
Output Current	I_{out}	500	mA
Output Voltage	V_{out}	$V_{ss}-0.3 \sim V_{in}+0.3$	V
Continuous Total Power Dissipation	P_D	TO-92	500
		SOT-23	150
		SOT-89	500
Operating Ambient Temperature	T_{opr}	-40~+85	$^{\circ}$ C
Storage Temperature	T_{stg}	-40~+125	$^{\circ}$ C

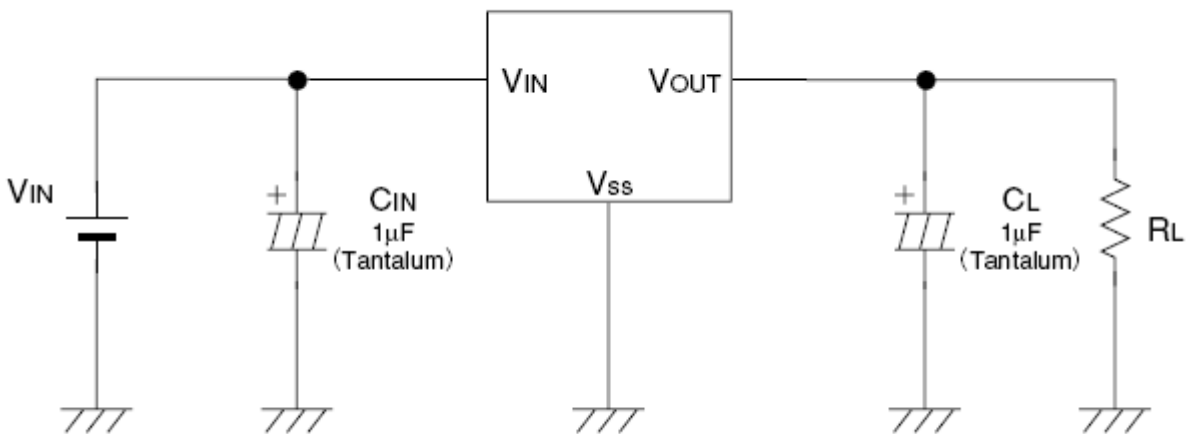
Pin Configuration



Block Diagram



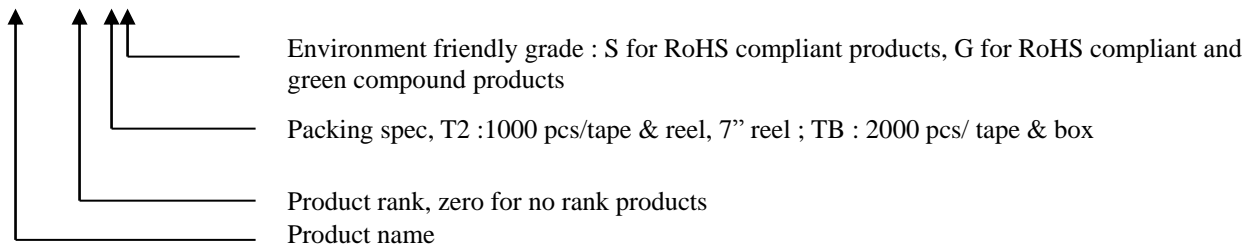
Typical Application Circuit





Ordering Information

Device	Output Voltage	Package	Shipping
LM1114-1.8 A3-0-TB-G	1.8V	TO-92 (Pb-free lead plating and halogen-free package)	Tape & Box / 2K
LM1114-1.8 M3-0-T2-G	1.8V	SOT-89 (Pb-free lead plating and halogen-free package)	Tape & Reel / 1K
LM1114-1.8 N3-0-T1-G	1.8V	SOT-23 (Pb-free lead plating and halogen-free package)	Tape & Reel / 3K
LM1114-2.5 A3-0-TB-G	2.5V	TO-92 (Pb-free lead plating and halogen-free package)	Tape & Box / 2K
LM1114-2.5 M3-0-T2-G	2.5V	SOT-89 (Pb-free lead plating and halogen-free package)	Tape & Reel / 1K
LM1114-2.5 N3-0-T1-G	2.5V	SOT-23 (Pb-free lead plating and halogen-free package)	Tape & Reel / 3K
LM1114-3.0 A3-0-TB-G	3.0V	TO-92 (Pb-free lead plating and halogen-free package)	Tape & Box / 2K
LM1114-3.0 M3-0-T2-G	3.0V	SOT-89 (Pb-free lead plating and halogen-free package)	Tape & Reel / 1K
LM1114-3.0 N3-0-T1-G	3.0V	SOT-23 (Pb-free lead plating and halogen-free package)	Tape & Reel / 3K
LM1114-3.3 A3-0-TB-G	3.3V	TO-92 (Pb-free lead plating and halogen-free package)	Tape & Box / 2K
LM1114-3.3 M3-0-T2-G	3.3V	SOT-89 (Pb-free lead plating and halogen-free package)	Tape & Reel / 1K
LM1114-3.3 N3-0-T1-G	3.3V	SOT-23 (Pb-free lead plating and halogen-free package)	Tape & Reel / 3K
LM1114-3.6A3-0-TB-G	3.6V	TO-92 (Pb-free lead plating and halogen-free package)	Tape & Box / 2K
LM1114-3.6M3-0-T2-G	3.6V	SOT-89 (Pb-free lead plating and halogen-free package)	Tape & Reel / 1K
LM1114-3.6 N3-0-T1-G	3.6V	SOT-23 (Pb-free lead plating and halogen-free package)	Tape & Reel / 3K
LM1114-5.0 A3-0-TB-G	5.0V	TO-92 (Pb-free lead plating and halogen-free package)	Tape & Box / 2K
LM1114-5.0 M3-0-T2-G	5.0V	SOT-89 (Pb-free lead plating and halogen-free package)	Tape & Reel / 1K
LM1114-5.0N3-0-T1-G	5.0V	SOT-23 (Pb-free lead plating and halogen-free package)	Tape & Reel / 3K





**Electrical Characteristics @ $V_{IN}=5V, T_a=25^{\circ}C, C_{IN}=1\mu F(\text{tantalum}),$
 $C_{OUT}=1\mu F(\text{tantalum}),$ unless otherwise noted**

LM1114-1.8

Parameter	Conditions	Min	Typ	Max	Units	Circuit
Output Voltage	$I_o=40mA, V_{in}=2.8V$	1.764	1.800	1.836	V	1
Line Regulation $\Delta V_{out}/\Delta V_{in}$	$I_o=40mA, 4V < V_{in} < 10V$	-	0.2	0.3	%/V	1
Load Regulation	$V_{in}=2.8V, 1mA < I_o < 40mA$	-	10	30	mV	1
Current Consumption	$V_{in}=2.8V$	-	1	4.5	μA	2
Dropout Voltage	$I_o=40mA$	-	0.2	0.36	V	1
	$I_o=80mA$	-	0.45	0.7	V	1

LM1114-2.5

Parameter	Conditions	Min	Typ	Max	Units	Circuit
Output Voltage	$I_o=40mA, V_{in}=4V$	2.450	2.500	2.550	V	1
Line Regulation $\Delta V_{out}/\Delta V_{in}$	$I_o=40mA, 4V < V_{in} < 10V$	-	0.2	0.3	%/V	1
Load Regulation	$V_{in}=4V, 1mA < I_o < 80mA$	-	15	40	mV	1
Current Consumption	$V_{in}=4V$	-	1	4.5	μA	2
Dropout Voltage	$I_o=80mA$	-	0.2	0.36	V	1
	$I_o=160mA$	-	0.45	0.7	V	1

LM1114-3.0

Parameter	Conditions	Min	Typ	Max	Units	Circuit
Output Voltage	$I_o=40mA, V_{in}=4.0V$	2.940	3.000	3.060	V	1
Line Regulation $\Delta V_{out}/\Delta V_{in}$	$I_o=40mA, 4.0V < V_{in} < 10V$	-	0.2	0.3	%/V	1
Load Regulation	$V_{in}=6V, 1mA < I_o < 80mA$	-	15	40	mV	1
Current Consumption	$V_{in}=4.0V$	-	1	4.5	μA	2
Dropout Voltage	$I_o=80mA$	-	0.24	0.36	V	1
	$I_o=160mA$	-	0.5	0.7	V	1

LM1114-3.3

Parameter	Conditions	Min	Typ	Max	Units	Circuit
Output Voltage	$I_o=40mA, V_{in}=4.3V$	3.234	3.300	3.366	V	1
Line Regulation $\Delta V_{out}/\Delta V_{in}$	$I_o=40mA, 4.3V < V_{in} < 10V$	-	0.2	0.3	%/V	1
Load Regulation	$V_{in}=6V, 1mA < I_o < 80mA$	-	15	40	mV	1
Current Consumption	$V_{in}=4.3V$	-	1	4.5	μA	2
Dropout Voltage	$I_o=80mA$	-	0.22	0.36	V	1
	$I_o=160mA$	-	0.45	0.7	V	1

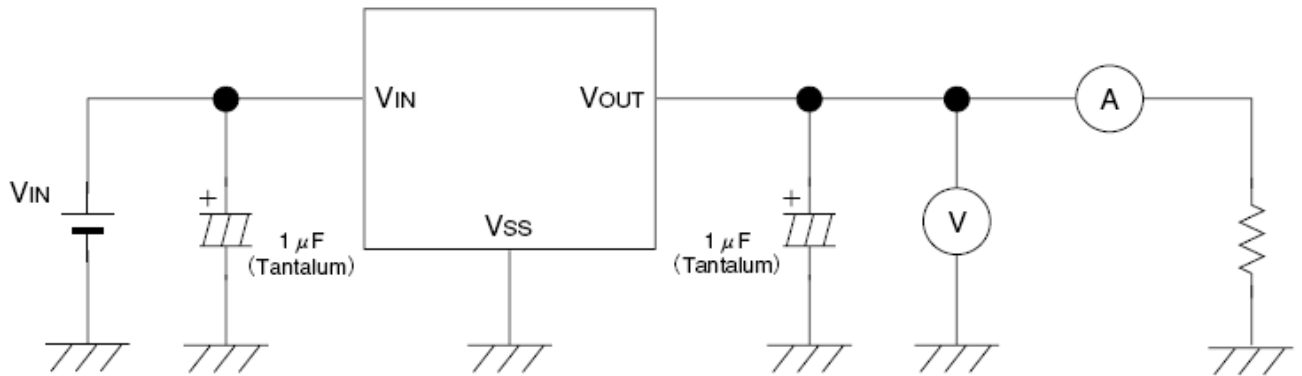
LM1114-3.6

Parameter	Conditions	Min	Typ	Max	Units	Circuit
Output Voltage	$I_o=40mA, V_{in}=4.6V$	3.522	3.600	3.672	V	1
Line Regulation $\Delta V_{out}/\Delta V_{in}$	$I_o=40mA, 4.6V < V_{in} < 10V$	-	0.2	0.3	%/V	1
Load Regulation	$V_{in}=6V, 1mA < I_o < 80mA$	-	15	40	mV	1
Current Consumption	$V_{in}=4.6V$	-	1	4.5	μA	2
Dropout Voltage	$I_o=80mA$	-	0.22	0.36	V	1
	$I_o=160mA$	-	0.45	0.7	V	1

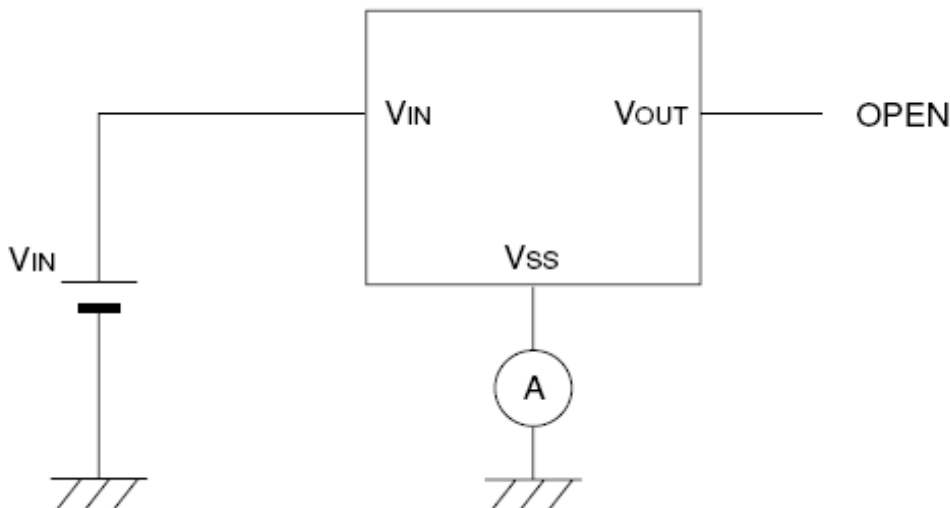
LM1114-5.0

Parameter	Conditions	Min	Typ	Max	Units	Circuit
Output Voltage	$I_o=40\text{mA}, V_{in}=6.0\text{V}$	4.900	5.000	5.100	V	1
Line Regulation $\Delta V_{out}/\Delta V_{in}V_{out}$	$I_o=40\text{mA}, 6.0\text{V}<V_{in}<10\text{V}$	-	0.2	0.3	%/V	1
Load Regulation	$V_{in}=6\text{V}, 1\text{mA}<I_o<100\text{mA}$	-	30	70	mV	1
Current Consumption	$V_{in}=6.0\text{V}$	-	1	4.5	μA	2
Dropout Voltage	$I_o=100\text{mA}$	-	0.21	0.3	V	1
	$I_o=200\text{mA}$	-	0.4	0.6	V	1

Test Circuits
Circuit 1



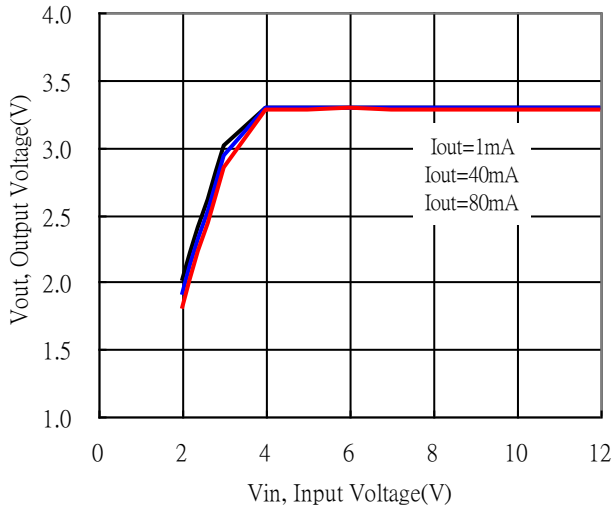
Circuit 2



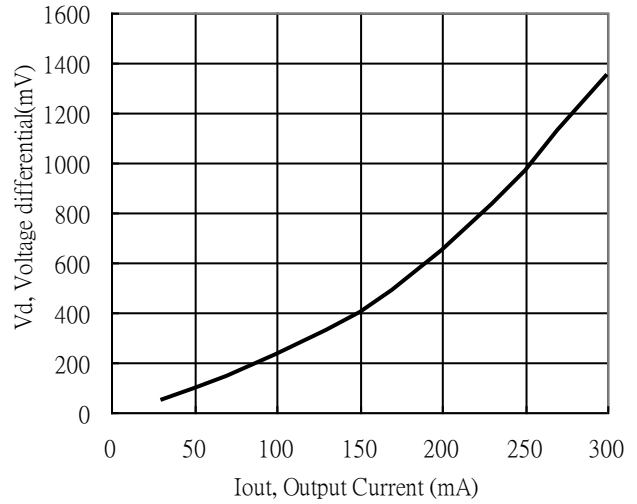
Characteristic Curves @C_{IN}=1μF(tantalum), C_{OUT}=1μF(tantalum)

LM1114-3.3

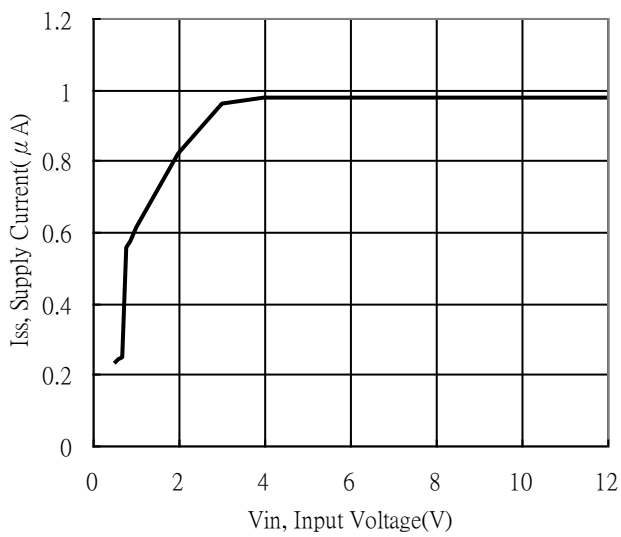
Output Voltage vs Input Voltage



Input-Output Voltage Differential

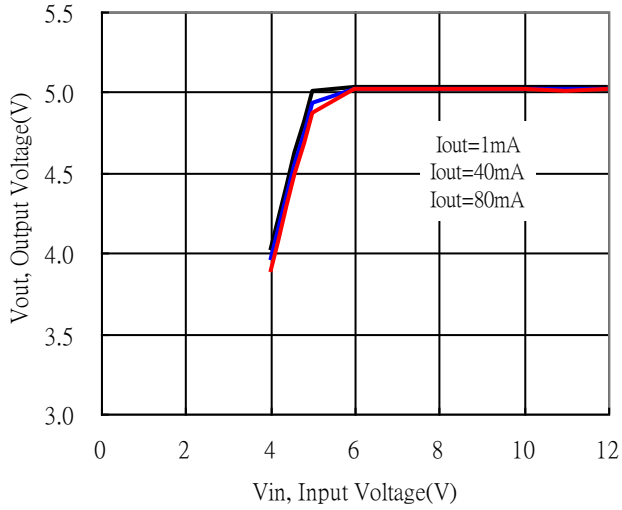


Supply Current vs Input Voltage

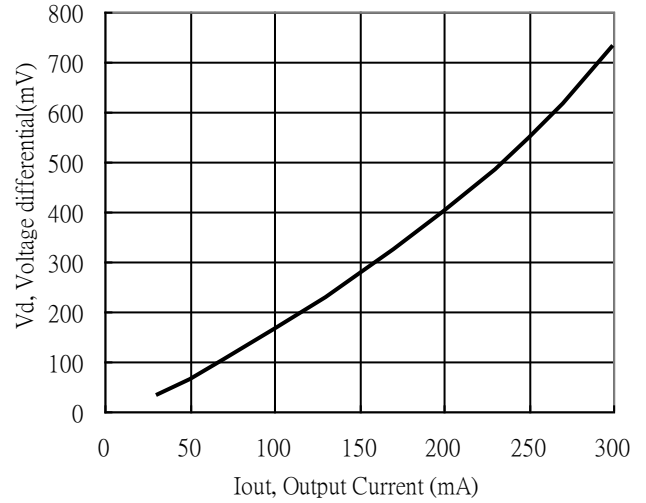


LM1114-5.0

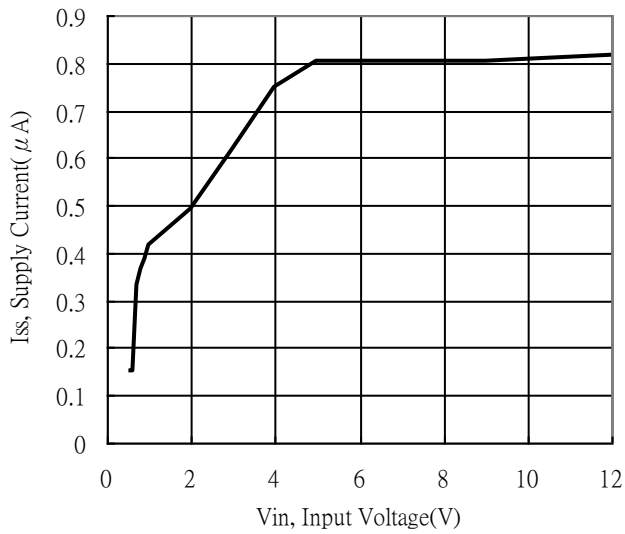
Output Voltage vs Input Voltage



Input-Output Voltage Differential



Supply Current vs Input Voltage



Recommended wave soldering condition

Product	Peak Temperature	Soldering Time
Pb-free devices	260 +0/-5 °C	5 +1/-1 seconds

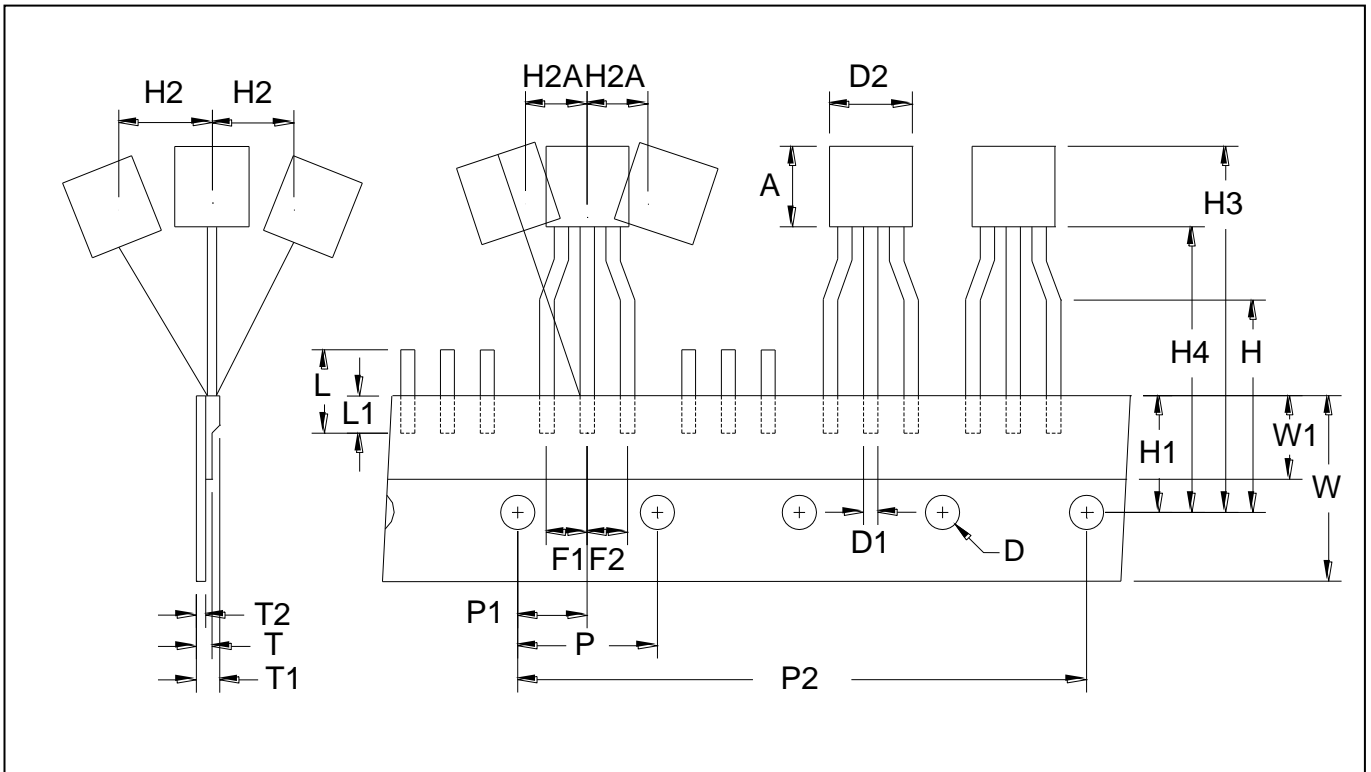
Recommended temperature profile for IR reflow



Profile feature	Sn-Pb eutectic Assembly	Pb-free Assembly
Average ramp-up rate (T _{smax} to T _p)	3°C/second max.	3°C/second max.
Preheat		
-Temperature Min(T _{s min})	100°C	150°C
-Temperature Max(T _{s max})	150°C	200°C
-Time(t _{s min} to t _{s max})	60-120 seconds	60-180 seconds
Time maintained above:		
-Temperature (T _L)	183°C	217°C
- Time (t _L)	60-150 seconds	60-150 seconds
Peak Temperature(T _p)	240 +0/-5 °C	260 +0/-5 °C
Time within 5°C of actual peak temperature(tp)	10-30 seconds	20-40 seconds
Ramp down rate	6°C/second max.	6°C/second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

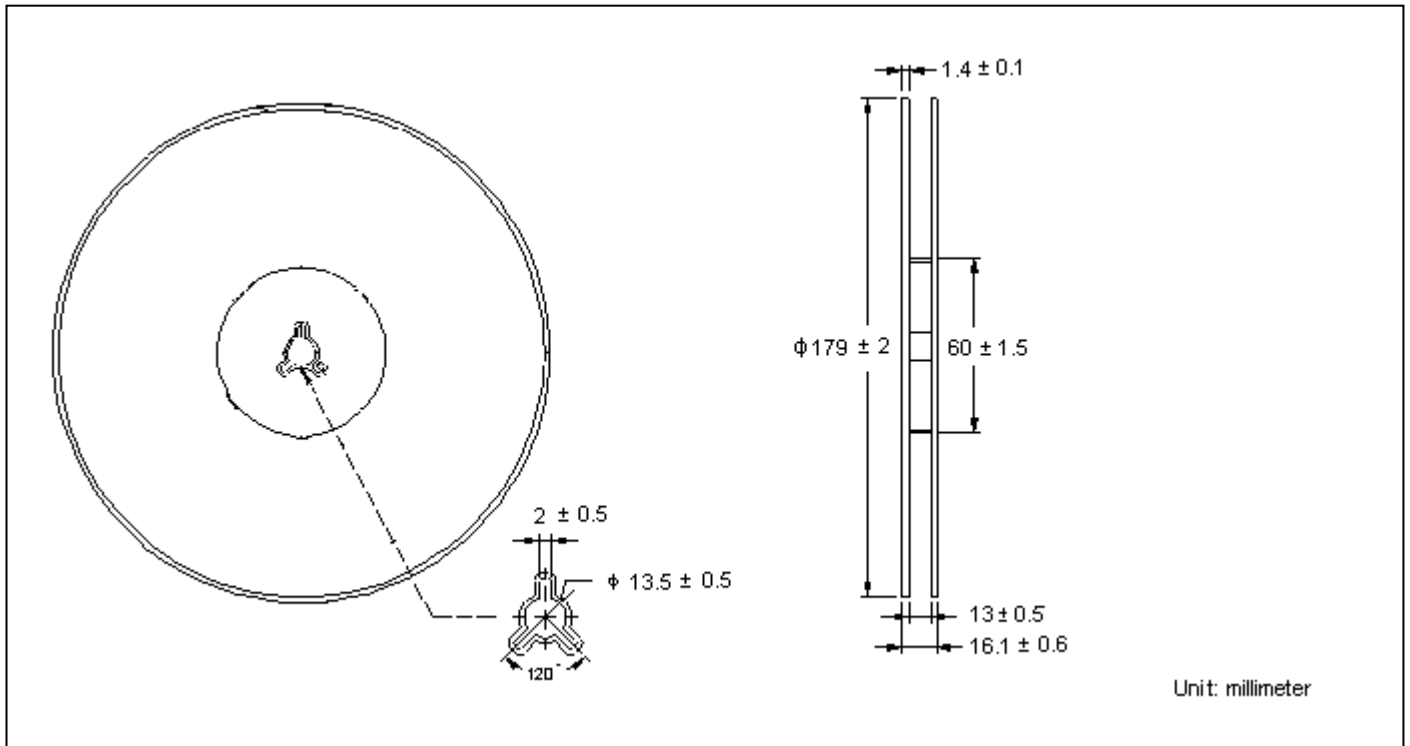
Note : All temperatures refer to topside of the package, measured on the package body surface.

TO-92 Taping Outline

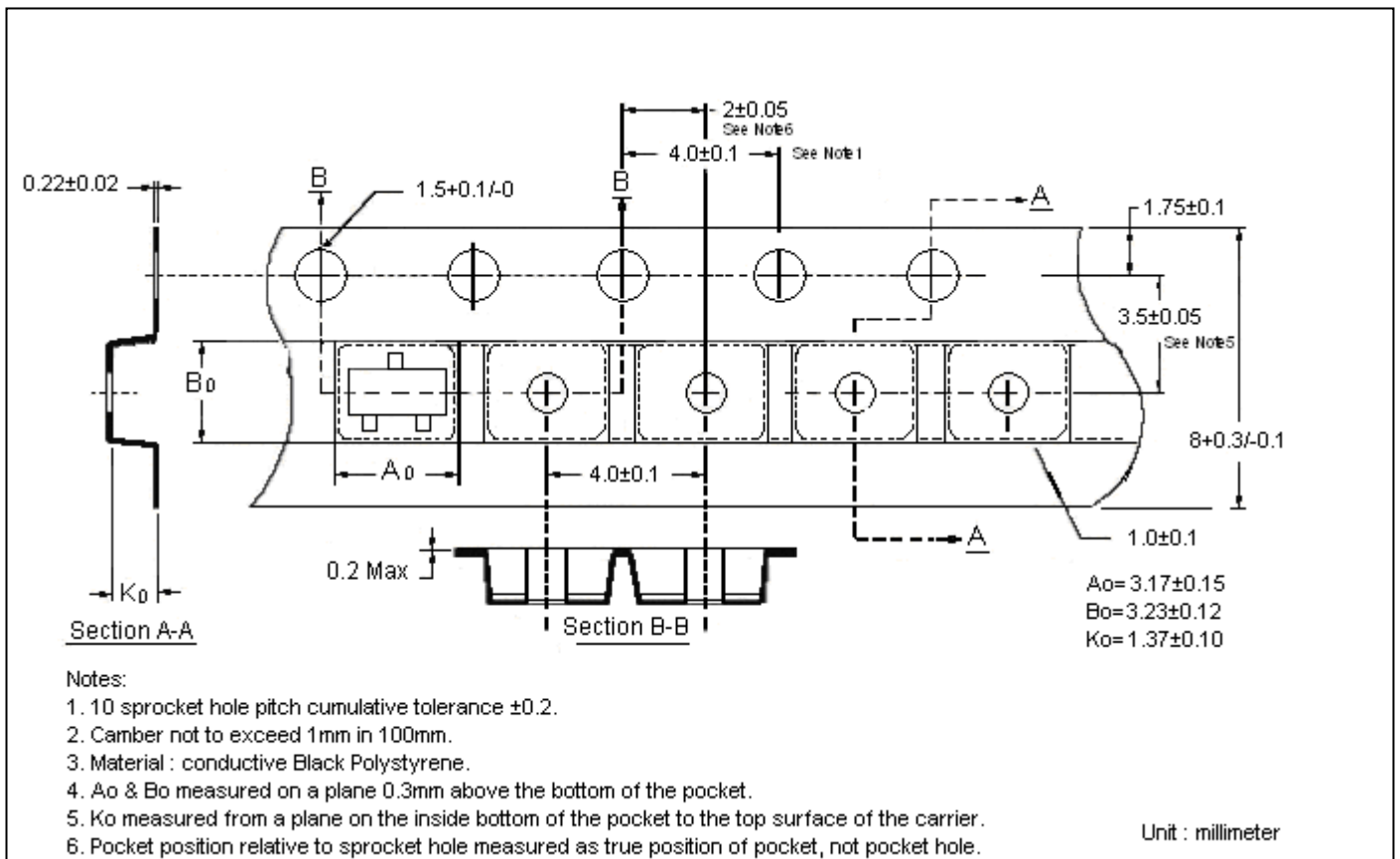


DIM	Item	Millimeters	
		Min.	Max.
A	Component body height	4.33	4.83
D	Tape Feed Diameter	3.80	4.20
D1	Lead Diameter	0.36	0.53
D2	Component Body Diameter	4.33	4.83
F1,F2	Component Lead Pitch	2.40	2.90
F1,F2	F1-F2	-	±0.3
H	Height Of Seating Plane	15.50	16.50
H1	Feed Hole Location	8.50	9.50
H2	Front To Rear Deflection	-	1
H2A	Deflection Left Or Right	-	1
H3	Component Height	-	27
H4	Feed Hole To Bottom Of Component	-	21
L	Lead Length After Component Removal	-	11
L1	Lead Wire Enclosure	2.50	-
P	Feed Hole Pitch	12.50	12.90
P1	Center Of Seating Plane Location	5.95	6.75
P2	4 Feed Hole Pitch	50.30	51.30
T	Over All Tape Thickness	-	0.55
T1	Total Taped Package Thickness	-	1.42
T2	Carrier Tape Thickness	0.36	0.68
W	Tape Width	17.50	19.00
W1	Adhesive Tape Width	5.00	7.00
-	20 pcs Pitch	253	255

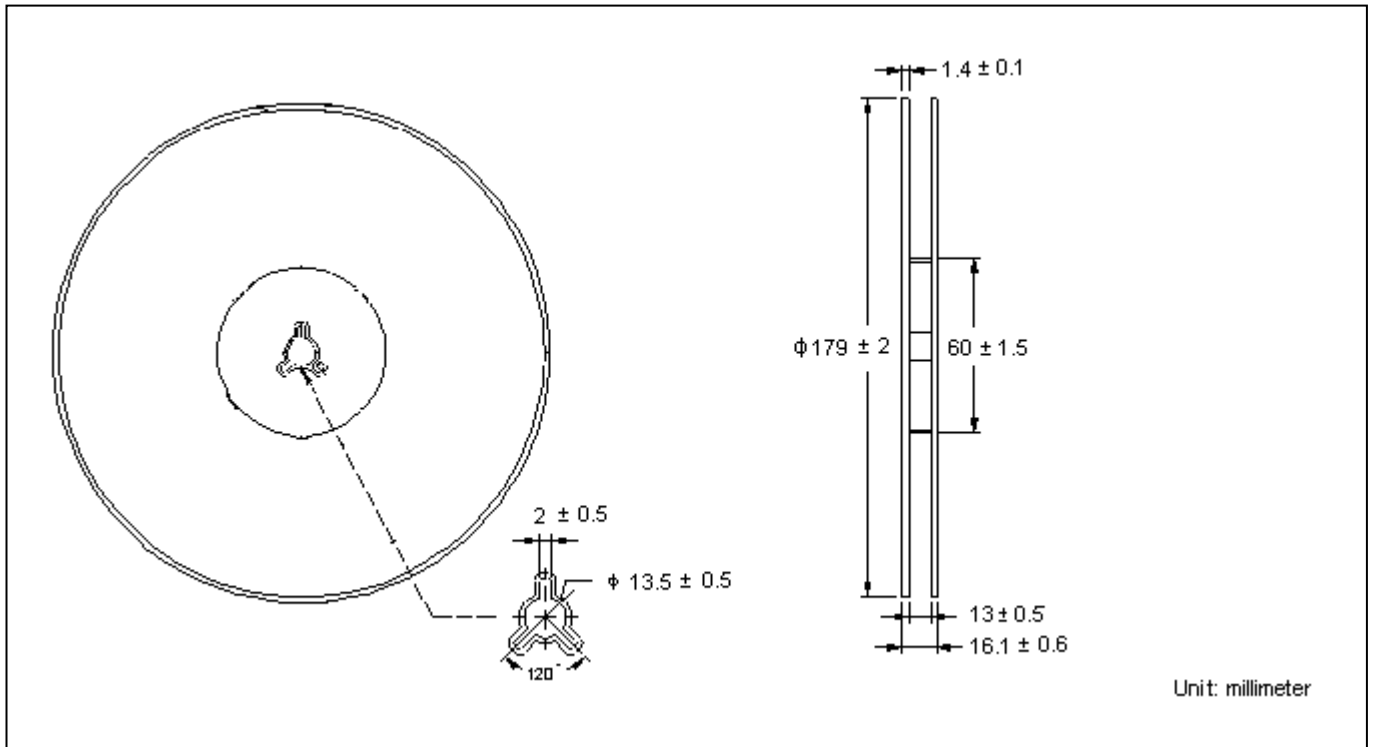
Reel Dimension



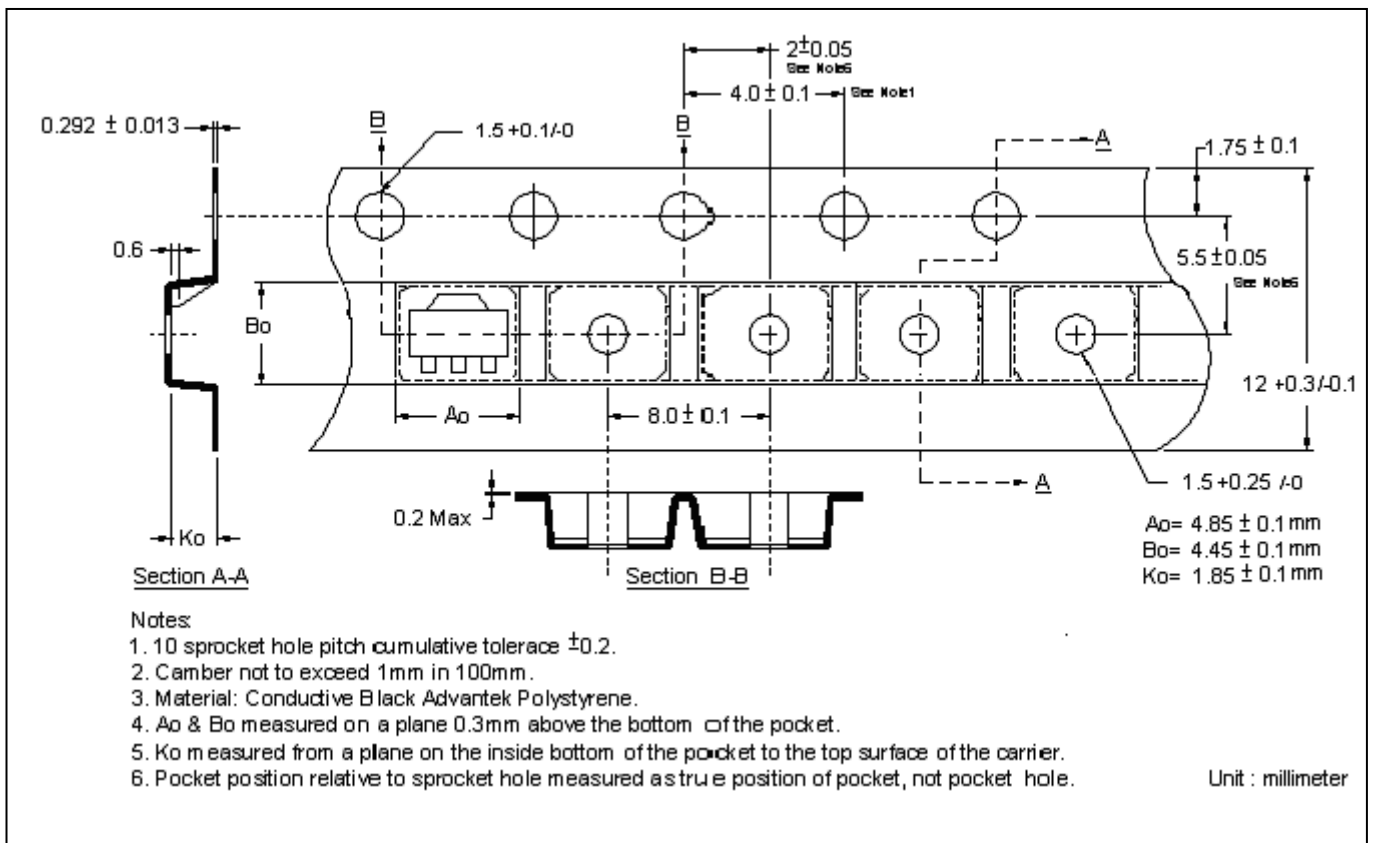
Carrier Tape Dimension



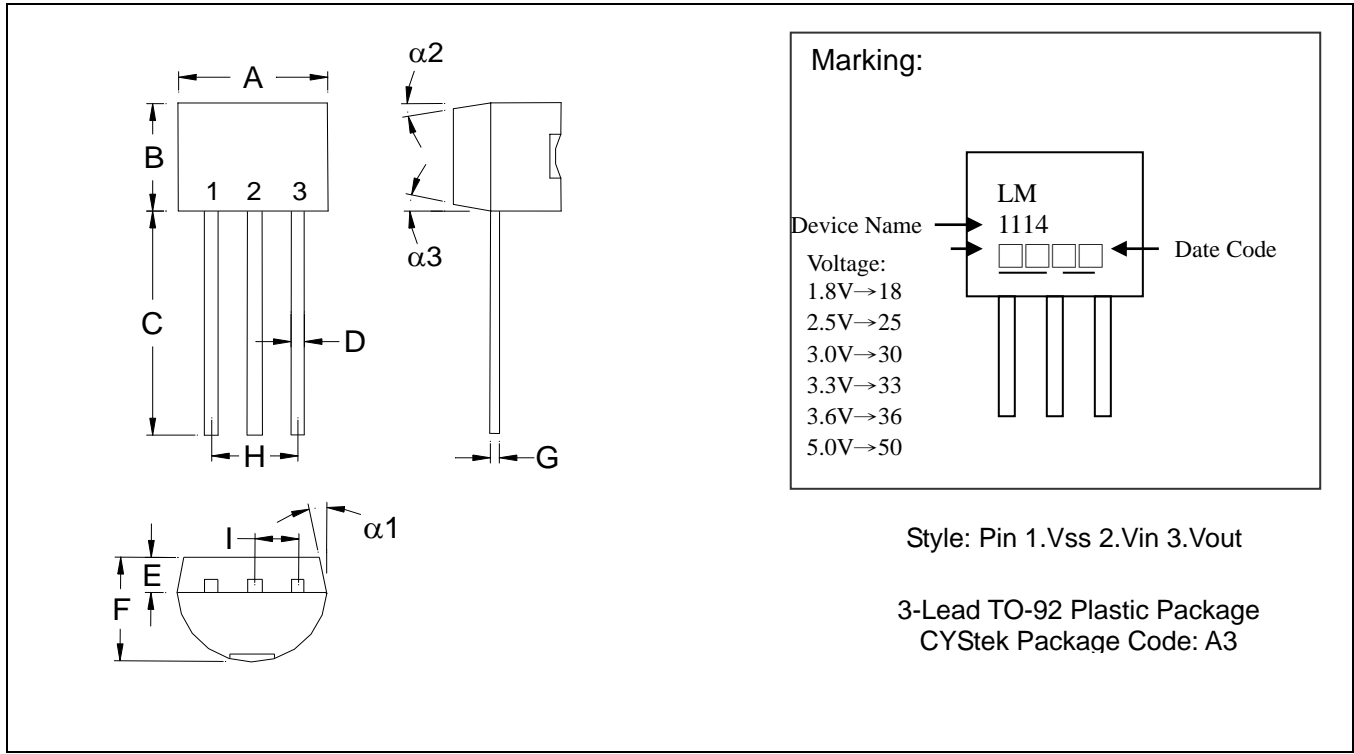
Reel Dimension for SOT-89



Carrier Tape Dimension



TO-92 Dimension



Marking:

Device Name → LM
 1114
 Voltage: 1.8V→18, 2.5V→25, 3.0V→30, 3.3V→33, 3.6V→36, 5.0V→50
 ← Date Code

Style: Pin 1.Vss 2.Vin 3.Vout

3-Lead TO-92 Plastic Package
 CYStek Package Code: A3

*: Typical

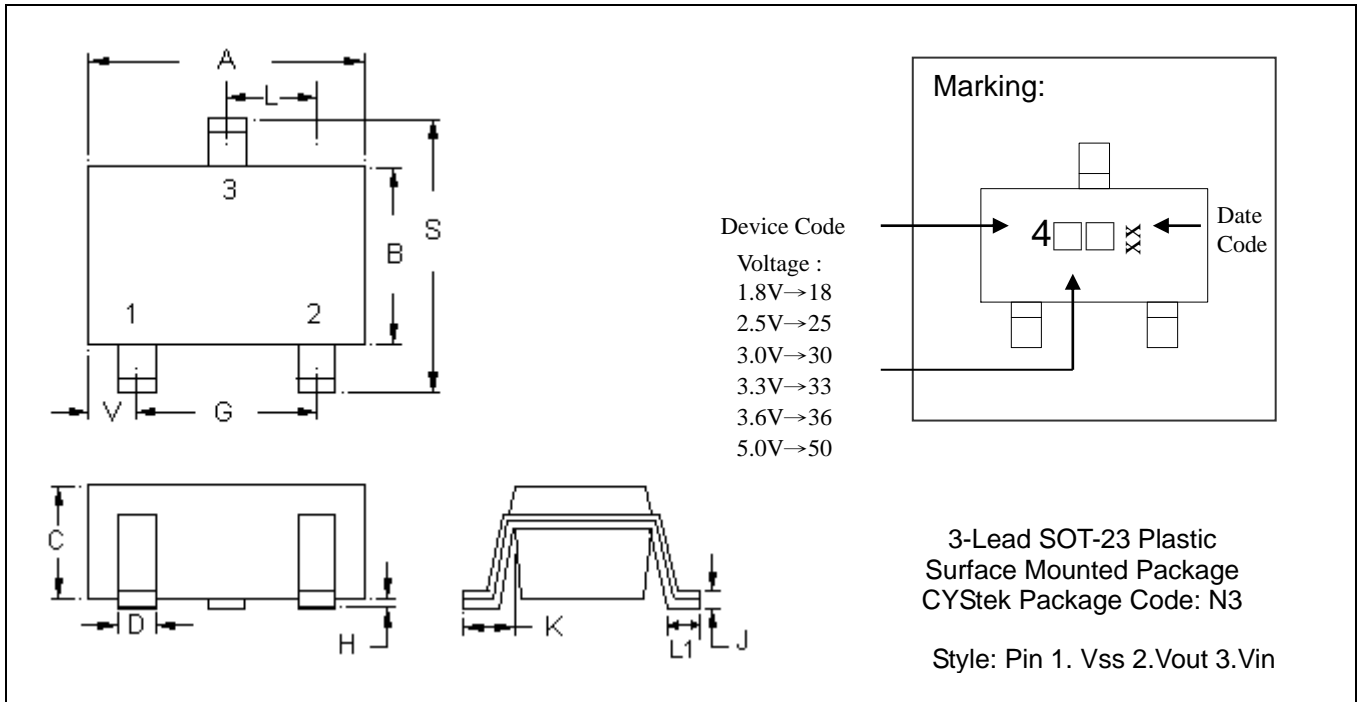
DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	0.1704	0.1902	4.33	4.83	G	0.0142	0.0220	0.36	0.56
B	0.1704	0.1902	4.33	4.83	H	-	*0.1000	-	*2.54
C	0.5000	-	12.70	-	I	-	*0.0500	-	*1.27
D	0.0142	0.0220	0.36	0.56	α1	-	*5°	-	*5°
E	-	*0.0500	-	*1.27	α2	-	*2°	-	*2°
F	0.1323	0.1480	3.36	3.76	α3	-	*2°	-	*2°

Notes: 1.Dimension and tolerance based on our Spec. dated Apr. 18,2002.
 2.Controlling dimension: millimeters.
 3.Maximum lead thickness includes lead finish thickness, and minimum lead thickness is the minimum thickness of base material.
 4.If there is any question with packing specification or packing method, please contact your local CYStek sales office.

Material:

- Lead: Pure tin plated.
- Mold Compound: Epoxy resin family, flammability solid burning class: UL94V-0.

SOT-23 Dimension



*: Typical

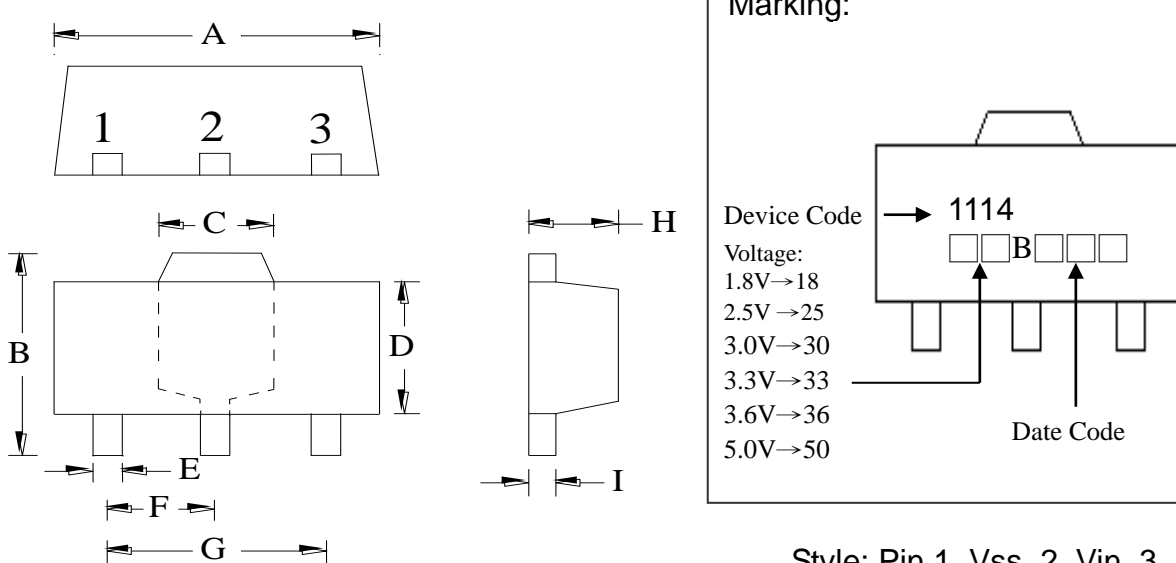
DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	0.1102	0.1204	2.80	3.04	J	0.0032	0.0079	0.08	0.20
B	0.0472	0.0669	1.20	1.70	K	0.0118	0.0266	0.30	0.67
C	0.0335	0.0512	0.89	1.30	L	0.0335	0.0453	0.85	1.15
D	0.0118	0.0197	0.30	0.50	S	0.0830	0.1161	2.10	2.95
G	0.0669	0.0910	1.70	2.30	V	0.0098	0.0256	0.25	0.65
H	0.0000	0.0040	0.00	0.10	L1	0.0118	0.0197	0.30	0.50

- Notes:** 1.Dimension and tolerance based on our Spec. dated Feb. 18,2002.
 2.Controlling dimension: millimeters.
 3.Maximum lead thickness includes lead finish thickness, and minimum lead thickness is the minimum thickness of base material.
 4.If there is any question with packing specification or packing method, please contact your local CYCtek sales office.

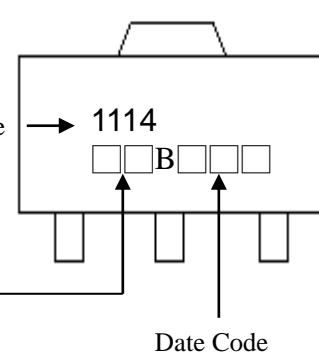
Material:

- Lead: Pure tin plated.
- Mold Compound: Epoxy resin family, flammability solid burning class: UL94V-0.

SOT-89 Dimension



Marking:



Device Code → 1114
 Voltage:
 1.8V → 18
 2.5V → 25
 3.0V → 30
 3.3V → 33
 3.6V → 36
 5.0V → 50

Date Code

Style: Pin 1. Vss 2. Vin 3. Vout

3-Lead SOT-89 Plastic
 Surface Mounted Package
 CYStek Package Code: M3

DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	0.1732	0.1811	4.40	4.60	F	0.0591	TYP	1.50	TYP
B	0.1551	0.1673	3.94	4.25	G	0.1181	TYP	3.00	TYP
C	0.0610	REF	1.55	REF	H	0.0551	0.0630	1.40	1.60
D	0.0906	0.1024	2.30	2.60	I	0.0138	0.0173	0.35	0.44
E	0.0126	0.0205	0.32	0.52					

Notes: 1. Controlling dimension: millimeters.
 2. Maximum lead thickness includes lead finish thickness, and minimum lead thickness is the minimum thickness of base material.
 3. If there is any question with packing specification or packing method, please contact your local CYStek sales office.

Material:

- Lead: Pure tin plated.
- Mold Compound: Epoxy resin family, flammability solid burning class: UL94V-0.

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